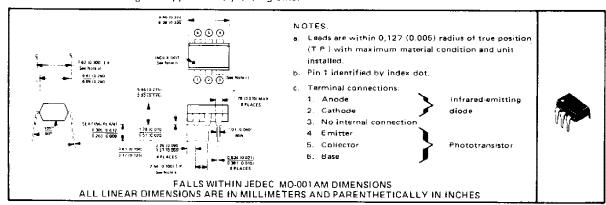
# COMPATIBLE WITH STANDARD TTL INTEGRATED CIRCUITS

- Gallium Arsenide Diode Infrared Source Optically Coupled to a Silicon N-P-N Phototransistor
- High Direct-Current Transfer Ratio
- High-Voltage Electrical Isolation . . . 2.5-kV, 1.5-kV, or 0.5-kV Rating
- Plastic Dual-In-Line Package
- High-Speed Switching . . .  $t_f = 2 \mu s$ ,  $t_f = 2 \mu s$  Typical

#### mechanical data

The package consists of a gallium arsenide infrared-emitting diode and an n-p-n silicon phototransistor mounted on a 6-lead frame encapsulated within an electrically nonconductive plastic compound. The case will withstand soldering temperature with no deformation and device performance characteristics remain stable when operated in high-humidity conditions. Unit weight is approximately 0.52 grams.



### absolute maximum ratings at 25°C free-air temperature (unless otherwise noted)

*Peak Input-to-Output Voltage:	4N25,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	± 2.5 kV
	4N26, 4N27	± 1.5 kV
	4N28	±0.5 kV
*Collector-Base Voltage		70 V
*Collector-Emitter Voltage (See	Note 1	30 V
*Emitter-Collector Voltage		
Emitter-Base Voltage		., 7 V
*Input-Diode Reverse Voltage		3 V
*Input-Diode Continuous Forwa	d Current at (or below) 25°C Free-Air Tem	nperature (See Note 2) 80 mA
*Input Diode Peak Forward Cur	ent ( $t_W = 300 \mu s$ , duty cycle = 2%)	
*Continuous Power Dissipation	at (or below) 25°C Free-Air Temperature:	
Infrared-Emitting Diode (Se	Note 3)	150 mW
Phototransistor (See Note 3	1	
Total, Infrared-Emitting Dio	e plus Phototransistor (See Note 4)	250 mW
*Storage Temperature Range .		
*Lead Temperature 1,6 mm (1/	6 inch) from Case for 10 Seconds	

\*JEDEC registered data. This data sheet contains all applicable JEDEC-registered data in effect at the time of publication.

- NOTES: 1. This value applies when the base-emitter diode is open-circulated.
  - 2. Derate linearly to 100 °C free-air temperature at the rate of 1.33 mA/°C.
  - 3. Derate linearly to 100 °C free-air temperature at the rate of 2 mW/ °C.
  - Derate linearly to 100 °C free-air temperature at the rate of 3.33 mW/°C.



# electrical characteristics at 25 °C free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		4N25, 4N26			4N27,4N28		
				MIN TYP MA		MIN TYP MAX		UNIT	
*V(BR)CBO	Collector-Base Breakdown Voltage	IC = 100 µA, IE = 0, IF = 0	70			70			٧
*VIBRICEO	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = 1 mA, I <sub>B</sub> = 0, I <sub>F</sub> = 0	30			30			V
*V(BR)ECO	Emitter-Collector Breakdown Voltage	i <sub>E</sub> = 100 μA, i <sub>B</sub> = 0, i <sub>F</sub> = 0	7		-	7	•		V
*IR	Input Diode Static Reverse Current	VR = 3 V			100			100	μА
*IC(on	On-State Collector Current [Phototransistor Operation]	V <sub>CE</sub> - 10 V, I <sub>B</sub> = 0, I <sub>F</sub> = 10 mA	2	5		1	3		mΑ
I <sub>C(on)</sub>	On-State Collector Current (Photodiode Operation)	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, I <sub>F</sub> = 10 mA		20			20	<u> </u>	μД
*IC(off)	Off-State Collector Current [Phototransistor Operation]	V <sub>CE</sub> = 10 V, I <sub>B</sub> = 0, I <sub>F</sub> = 0		1	50		1	50	nΑ
*IC(off)	Off-State Collector current (Photodiode Operation)	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, I <sub>F</sub> = 0		0.1	20		0.1	20	nΑ
*VF	Input Diode Static Forward Voltage	IF - 10 mA		1.25	1.5		1.25	1.5	٧
*VCE(sat)	Collector-Emitter Saturation Voltage	IC = 2 mA, IB = 0, IF = 50 mA		0.25	0.5		0.25	0.5	٧
rio	Input-to-Output Internal resistance	Vin-out = ±2.5 kV for 4N25, ±1.5 kV for 4N26, 4N27, ±0.5 kV for 4N28, See Note 5	1011	1012	•	10"	1012		Ω
Cio	Input-to-Output Capacitance	Vin-out = 0, f = 1 MHz, See Note 5		1			1		рF

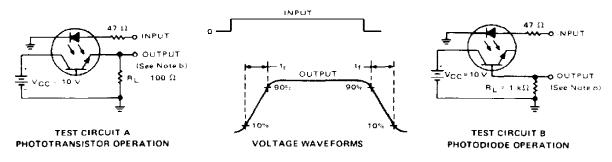
<sup>\*</sup>JEDEC registered data

### switching characteristics at 25 °C free-air temperature

	PAR	AMETER	TEST CONDITIONS		TYP	UNIT
t <sub>r</sub>	Rise Time	Phototransistor	V <sub>CC</sub> = 10 V,	$lg = 0$ , $l_{C(on)} = 2 mA$ ,	2	]
tf	Fall Time	Operation	R <sub>L</sub> ≈ 100 Ω,	See Test Circuit A of Figure 1	2	μ5
tr	Rise Time	Photodiode	V <sub>CC</sub> = 10 V,	$i_E = 0$ , $i_{C(on)} = 20 \mu A$ ,	1	μS
tf	Fall Time	Operation	R <sub>L</sub> ≃ 1 kΩ,	See Test Circuit B of Figure 1	1	

### PARAMETER MEASUREMENT INFORMATION

Adjust amplitude of input pulse for:  $i_{C(on)} = 2$  mA (Test Circuit A) or  $i_{C(on)} = 20$   $\mu$ A (Test Circuit B)



- NOTES a. The input waveform is supplied by a generator with the following characteristics:  $Z_{out} = 50 \Omega$ ,  $t_r \le 15$  ns. duty cycle  $\approx 1\%$ .  $t_{tot} = 100 \mu s$ .
  - $t_W=100~\mu$ s. b. The output waveform is monitored on an oscilloscope with the following characteristics:  $t_r \le 12$  ns,  $R_{in} \ge 1~M\Omega$ ,  $C_{in} \le 20~pF$ .

FIGURE 1 - SWITCHING TIMES



NOTE 5: These parameters are measured between both input diode leads shorted together and all the phototransistor leads shorted together

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